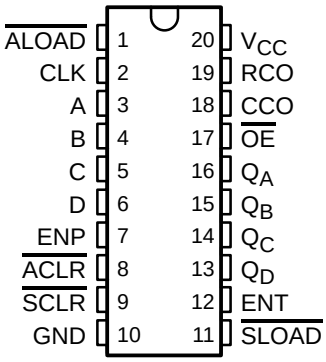
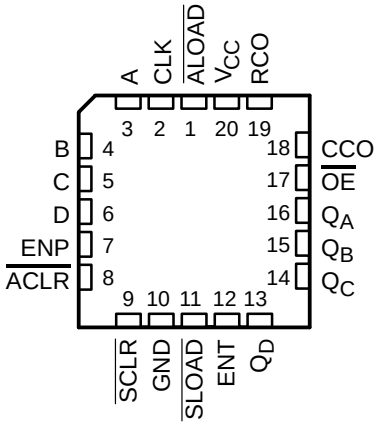
- **Carry Output for n-Bit Cascading**
- **Buffer-Type Outputs Drive Bus Lines Directly**
- **Choice of Asynchronous or Synchronous Clearing and Loading**
- **Internal Look-Ahead Circuitry for Fast Cascading**
- **Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

SN54ALS561A . . . J PACKAGE
SN74ALS561A . . . DW OR N PACKAGE
(TOP VIEW)



SN54ALS561A . . . FK PACKAGE
(TOP VIEW)



description

These binary counters are programmable and offer synchronous and asynchronous clearing as well as synchronous and asynchronous loading. All synchronous functions are executed on the positive-going edge of the clock.

The clear function is initiated by applying a low level to either asynchronous clear ($\overline{\text{ACLR}}$) or synchronous clear ($\overline{\text{SCLR}}$). $\overline{\text{ACLR}}$ (direct clear) overrides all other functions of the device, while $\overline{\text{SCLR}}$ overrides only the other synchronous functions. Data is loaded from the A, B, C, and D inputs by applying a low level to asynchronous load ($\overline{\text{ALOAD}}$) or by the combination of a low level at synchronous load ($\overline{\text{SLOAD}}$) and a positive-going clock transition. The counting function is enabled only when enable P (ENP), enable T (ENT), $\overline{\text{ACLR}}$, $\overline{\text{ALOAD}}$, $\overline{\text{SCLR}}$, and $\overline{\text{SLOAD}}$ are all high.

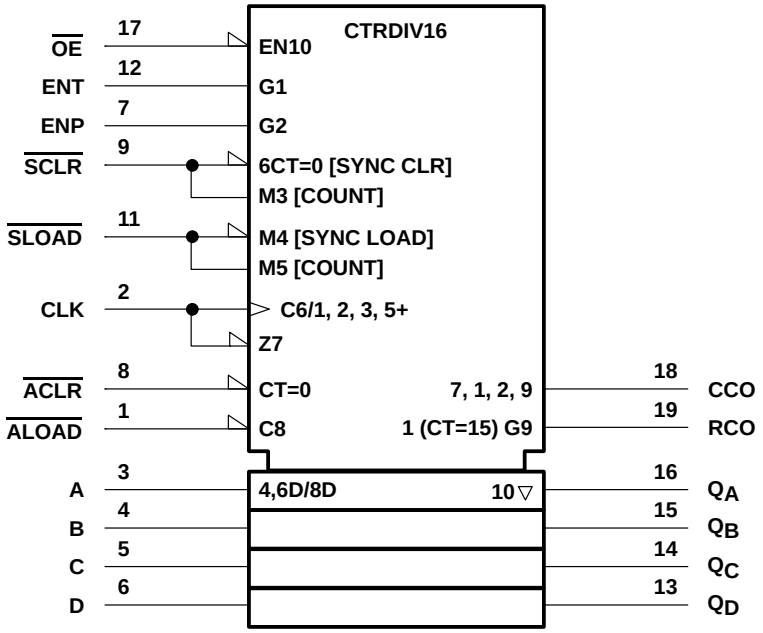
A high level at the output-enable ($\overline{\text{OE}}$) input forces the Q outputs into the high-impedance state, and a low level enables those outputs. Counting is independent of $\overline{\text{OE}}$. ENT is fed forward to enable the ripple-carry output (RCO) to produce a high-level pulse while the count is maximum (15). The clocked carry output (CCO) produces a high-level pulse for a duration equal to that of the low level of the clock when RCO is high and the counter is enabled (ENP and ENT are high); otherwise, CCO is low. CCO does not have the glitches commonly associated with a ripple-carry output. Cascading is normally accomplished by connecting RCO or CCO of the first counter to ENT of the next counter. However, for very high-speed counting, RCO should be used for cascading because CCO does not become active until the clock returns to the low level.

The SN54ALS561A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS561A is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

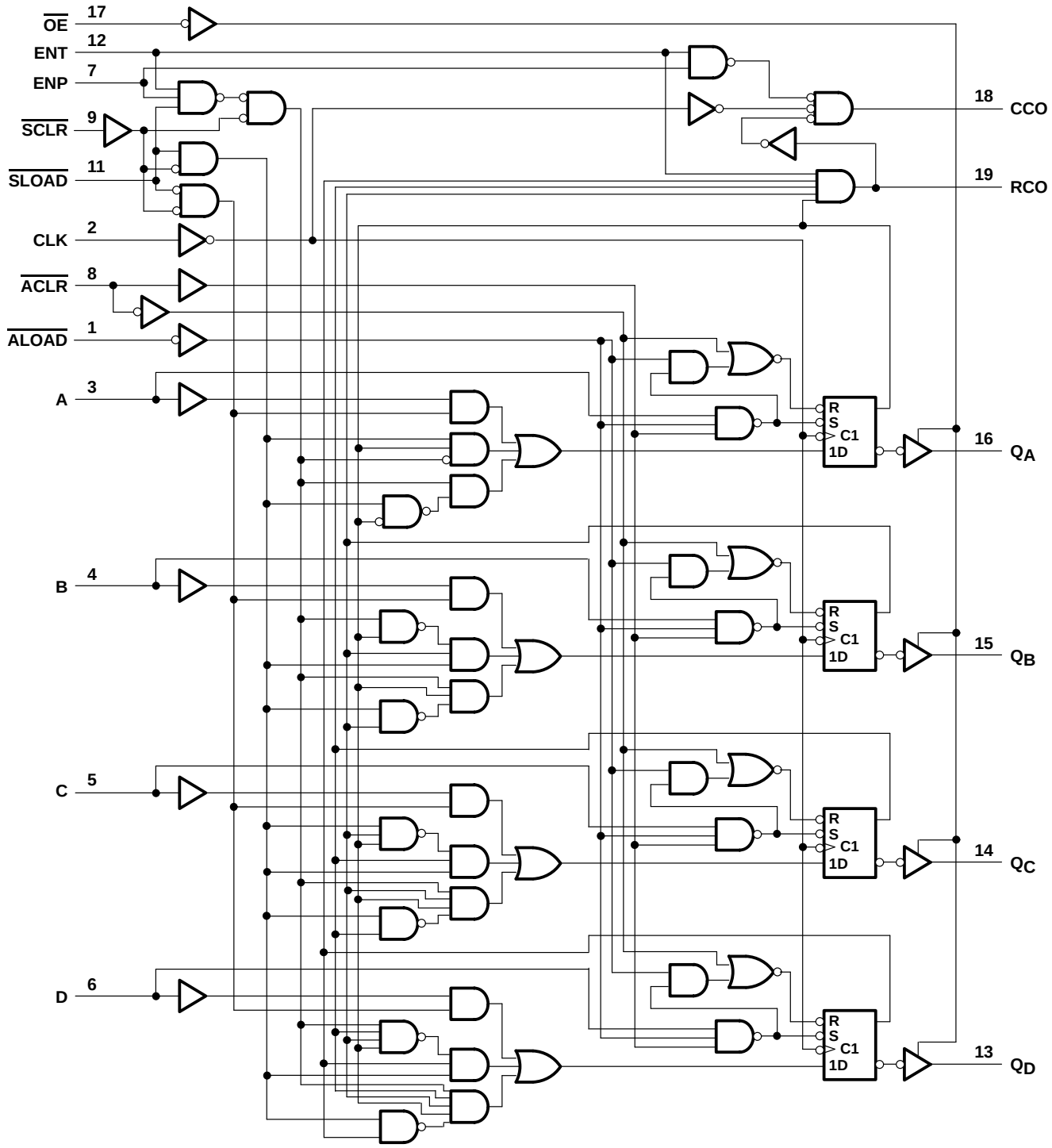
INPUTS								OPERATION
$\overline{OE}$	$\overline{ACLR}$	$\overline{ALOAD}$	$\overline{SCLR}$	$\overline{SLOAD}$	ENT	ENP	CLK	
H	X	X	X	X	X	X	X	Q outputs disabled
L	L	X	X	X	X	X	X	Asynchronous clear
L	H	L	X	X	X	X	X	Asynchronous load
L	H	H	L	X	X	X	↑	Synchronous clear
L	H	H	H	L	X	X	↑	Synchronous load
L	H	H	H	H	H	H	↑	Count
L	H	H	H	H	L	X	X	Inhibit counting
L	H	H	H	H	X	L	X	Inhibit counting

logic symbol†

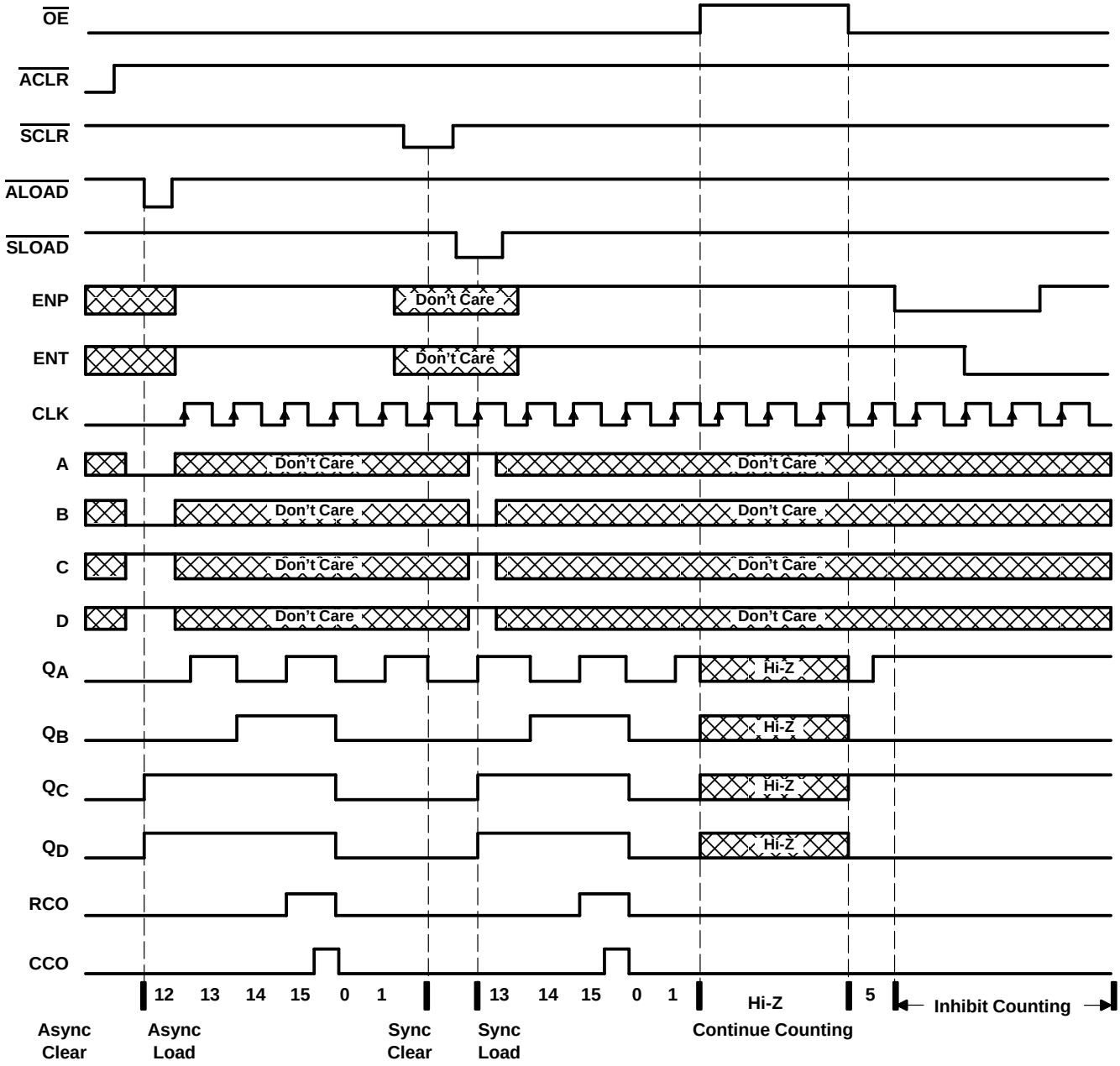


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



typical load, count, and inhibit sequences



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} . . . . . 7 V
Input voltage, V_I . . . . . 7 V
Operating free-air temperature range, T_A: SN54ALS561A . . . . . –55°C to 125°C
SN74ALS561A . . . . . 0°C to 70°C
Storage temperature range . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

				SN54ALS561A			SN74ALS561A			UNIT
				MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage			4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
I_{OH}	High-level output current	Q outputs				–1			–2.6	mA
		CCO and RCO				–0.4			–0.4	
I_{OL}	Low-level output current	Q outputs				12			24	mA
		CCO and RCO				4			8	
f_{clock}	Clock frequency			0		20	0		30	MHz
t_w	Pulse duration	$\overline{ACLR}$ or $\overline{ALOAD}$ low		20			15			ns
		CLK high		20			16.5			
		CLK low		25			16.5			
t_{su}	Setup time before CLK↑	ENP, ENT	High	25			20			ns
			Low	25			20			
		Data at A, B, C, D		25			20			
		$\overline{SCLR}$	Low	21			15			
			High (inactive)	35			30			
		$\overline{SLOAD}$	Low	20			15			
			High (inactive)	35			30			
		$\overline{ACLR}$ or $\overline{ALOAD}$ inactive		12			10			
t_h	Hold time after CLK↑ for data, ENP, ENT, $\overline{SCLR}$, or $\overline{SLOAD}$			0			0			ns
T_A	Operating free-air temperature			–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ALS561A			SN74ALS561A			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = –18 mA			–1.5			–1.5	V
V_{OH}	All outputs	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –0.4 mA	V_{CC} –2			V_{CC} –2			V
	Q outputs	V_{CC} = 4.5 V	I_{OH} = –1 mA	2.4	3.3					
			I_{OH} = –2.6 mA				2.4	3.2		
V_{OL}	Q outputs	V_{CC} = 4.5 V	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
			I_{OL} = 24 mA					0.35	0.5	
	CCO and RCO	V_{CC} = 4.5 V	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	
			I_{OL} = 8 mA					0.35	0.5	
I_{OZH}		V_{CC} = 5.5 V,	V_O = 2.7 V			20			20	µA
I_{OZL}		V_{CC} = 5.5 V,	V_O = 0.4 V			–20			–20	µA
I_I	ENP and ENT	V_{CC} = 5.5 V,	V_I = 7 V			0.2			0.2	mA
	Other inputs					0.1			0.1	
I_{IH}	ENP and ENT	V_{CC} = 5.5 V,	V_I = 2.7 V			40			40	µA
	Other inputs					20			20	
I_{IL}		V_{CC} = 5.5 V,	V_I = 0.4 V			–0.2			–0.2	mA
I_O‡	CCO and RCO	V_{CC} = 5.5 V,	V_O = 2.25 V	–15		–70	–15		–70	mA
	Q			–20		–112	–30		–112	
I_{CC}		V_{CC} = 5.5 V	Outputs high		17	27		17	27	mA
			Outputs low		21	33		21	33	
			Outputs disabled		22	36		22	36	

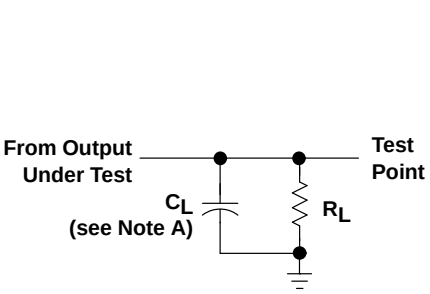
† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

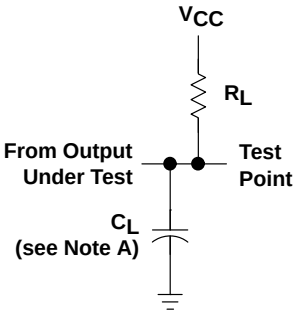
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAX†				UNIT
			SN54ALS561A		SN74ALS561A		
			MIN	MAX	MIN	MAX	
f_{max}			20		30		MHz
t_{PLH}	CLK	Any Q	4	15	4	12	ns
t_{PHL}			5	21	5	18	
t_{PLH}	CLK	RCO	9	35	9	29	ns
t_{PHL}			8	29	8	24	
t_{PLH}	CLK	CCO	8	35	8	26	ns
t_{PHL}			5	20	5	16	
t_{PLH}	$\overline{\text{ALOAD}}$	Any Q	10	38	10	35	ns
t_{PHL}			7	27	7	23	
t_{PLH}	$\overline{\text{ALOAD}}$	RCO	15	50	15	40	ns
t_{PHL}			12	35	12	30	
t_{PLH}	$\overline{\text{ALOAD}}$	CCO	25	65	25	55	ns
t_{PHL}			12	42	12	33	
t_{PLH}	A, B, C, or D	Any Q	8	35	8	30	ns
t_{PHL}			7	27	7	22	
t_{PLH}	ENT	RCO	5	20	5	16	ns
t_{PHL}			4	18	4	14	
t_{PLH}	ENT	CCO	12	35	12	32	ns
t_{PHL}			4	15	4	12	
t_{PLH}	ENP	CCO	5	22	5	18	ns
t_{PHL}			4	14	4	12	
t_{PHL}	$\overline{\text{ACLR}}$	Any Q	7	28	7	22	ns
t_{PZH}	$\overline{\text{OE}}$	Any Q	5	24	5	19	ns
t_{PZL}			8	28	8	23	
t_{PHZ}	$\overline{\text{OE}}$	Any Q	2	12	2	10	ns
t_{PLZ}			2	20	4	15	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

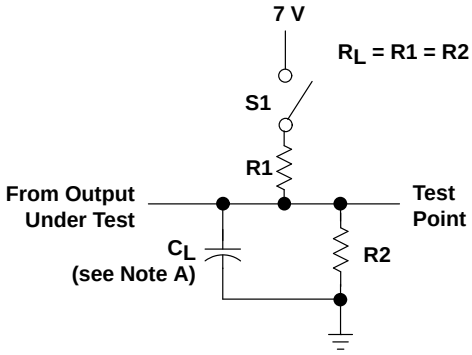
PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



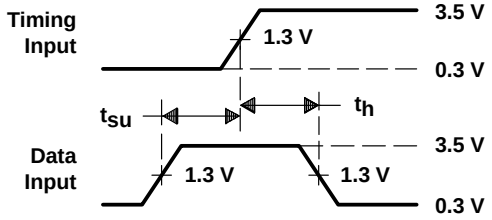
LOAD CIRCUIT FOR
BI-STATE
TOTEM-POLE OUTPUTS



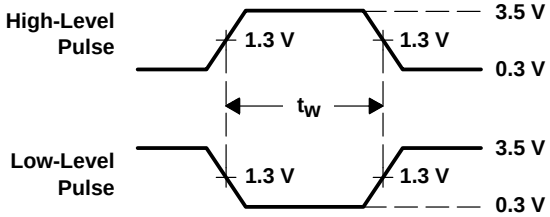
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



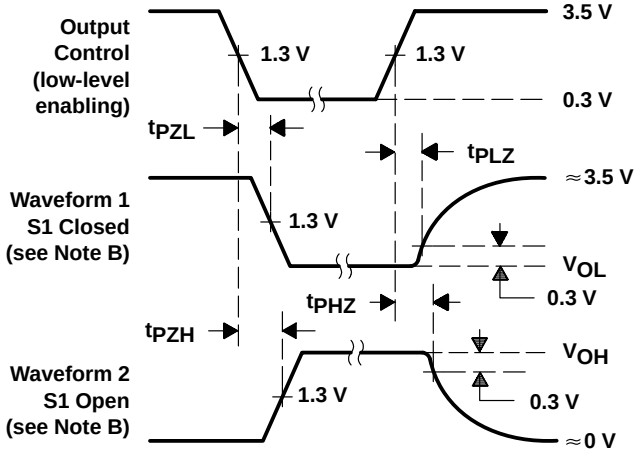
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



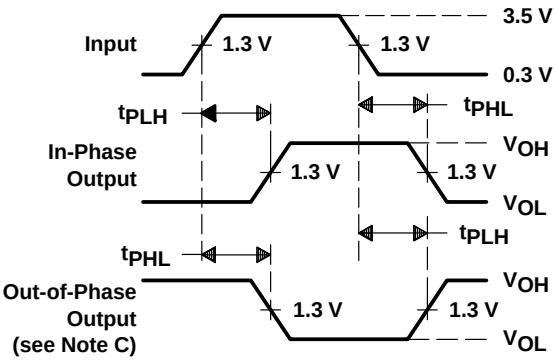
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.